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4/19/03

Docket No.  
90065.001020/17732.8011.00

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

Applicant	: Martin E. Kordes, et al.	) Examiner:
Serial No.	: 09/682,151 ✓	) Chris C. Chu
Filed	: 27 July 2001 ✓	) Art Unit:
For	: CONTACT METHOD FOR THIN SILICON CARBIDE EPITAXIAL LAYER AND SEMICONDUCTOR DEVICES FORMED BY THOSE METHODS ✓	) 2815

Assistant Commissioner For Patents  
Washington, DC 20231

AMENDMENT

In response to the office action mailed January 2, 2003, Applicants hereby  
amend the specification and drawings and will promptly submit a supplemental  
declaration.

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**AMENDMENT TRANSMITTAL LETTER (Large Entity)**

Applicant(s): Martin E. Kordes, et al.

Docket No.

90065.001020/17732.8011.00

Serial No.  
09/682,151

Filing Date  
July 27, 2001

Examiner  
Chris C. Shu

Group Art Unit  
2815

Invention: **CONTACT METHOD FOR THIN SILICON CARBIDE EPITAXIAL LAYER AND SEMICONDUCTOR DEVICES FORMED BY THOSE METHODS**

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

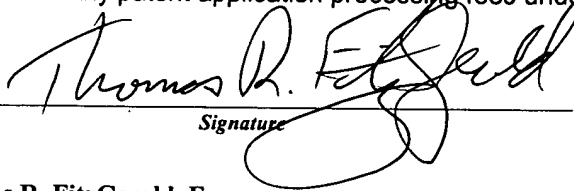
Transmitted herewith is an amendment in the above-identified application.

The fee has been calculated and is transmitted as shown below.

**CLAIMS AS AMENDED**

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	15 -	20 =	0 x	\$18.00	\$0.00
INDEP. CLAIMS	2 -	3 =	0 x	\$84.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00

- ☒ No additional fee is required for amendment.
- ☐ Please charge Deposit Account No. \_\_\_\_\_ in the amount of \_\_\_\_\_  
A duplicate copy of this sheet is enclosed.
- ☐ A check in the amount of \_\_\_\_\_ to cover the filing fee is enclosed.
- ☐ The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. \_\_\_\_\_  
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- ☐ Any additional filing fees required under 37 C.F.R. 1.16.
- ☐ Any patent application processing fees under 37 CFR 1.17.

  
Signature

Dated:

4/2/03

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I certify that this document and fee is being deposited on April 2, 2003 with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

  
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Kathleen A. Manczuk

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**CERTIFICATE OF MAILING BY FIRST CLASS MAIL (37 CFR 1.8)**

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I hereby certify that this Amendment (7 pages)

(Identify type of correspondence)

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